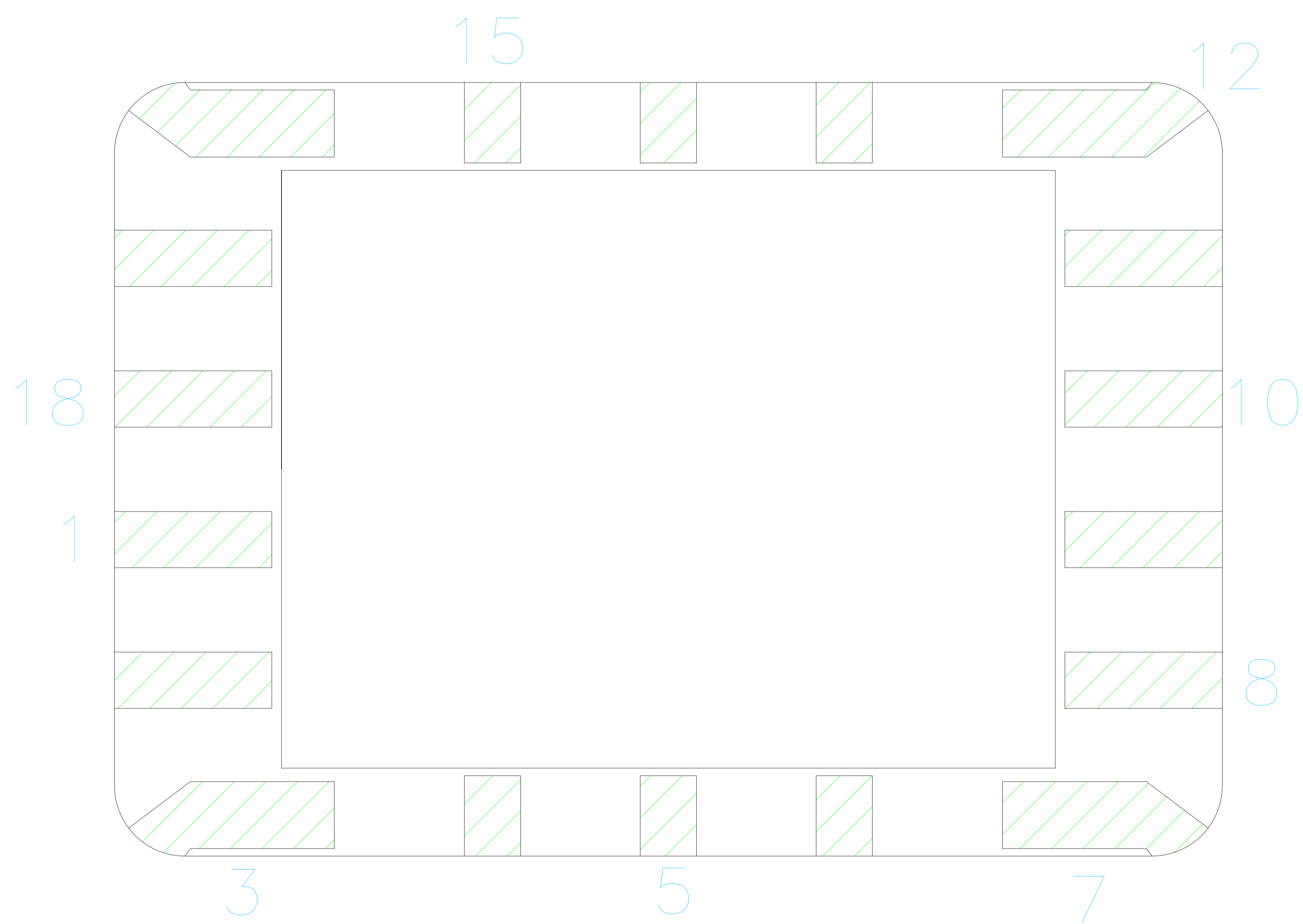
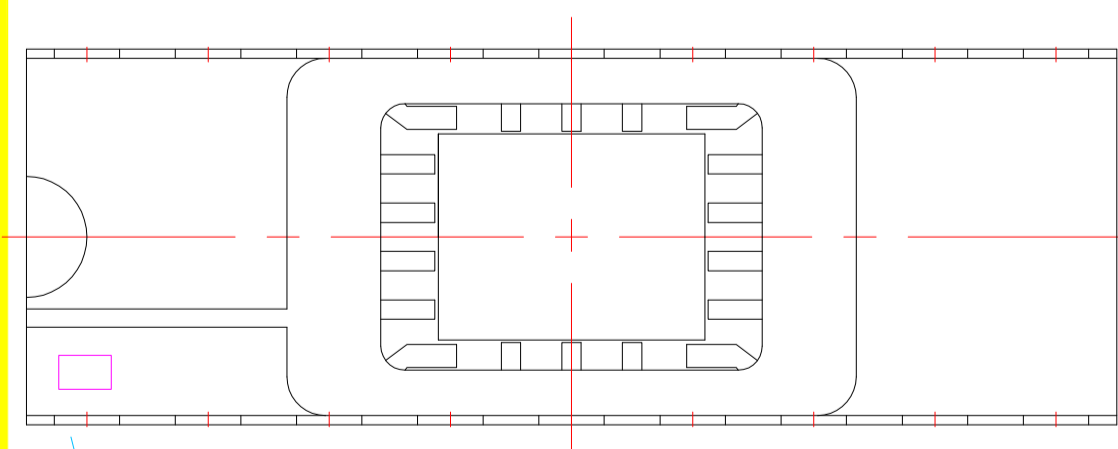


Bonding Diagram

DWG NO. : BCSB-018-31



CHECK BY CUSTOMER

 <p>NO.1</p>	Product Name	S/B-18	Die Size	N/A
	Pin Count	18	Pad Opening	N/A
	Body Type	300 x 900 mil	Pad Pitch	N/A
	Cavity Size	0.170 X 0.220 inch	Wire Count	N/A
CAD DRAW	DRAW BY :		CHECH BY :	